

## Rail-to-Rail CMOS Dual Operational Amplifier

- Rail-to-rail input and output voltage ranges
- Single (or dual) supply operation from 2.7V to 16V
- Extremely low input bias current: 1pA typ.
- Low input offset voltage: 2mV max.
- Specified for 600Ω and 100Ω loads
- Low supply current: 200μA/ampli ( $V_{CC} = 3V$ )
- Latch-up immunity
- ESD tolerance: 3kV
- Spice macromodel included in this specification

### Description

The TS912 is a rail-to-rail CMOS dual operational amplifier designed to operate with a single or dual supply voltage.

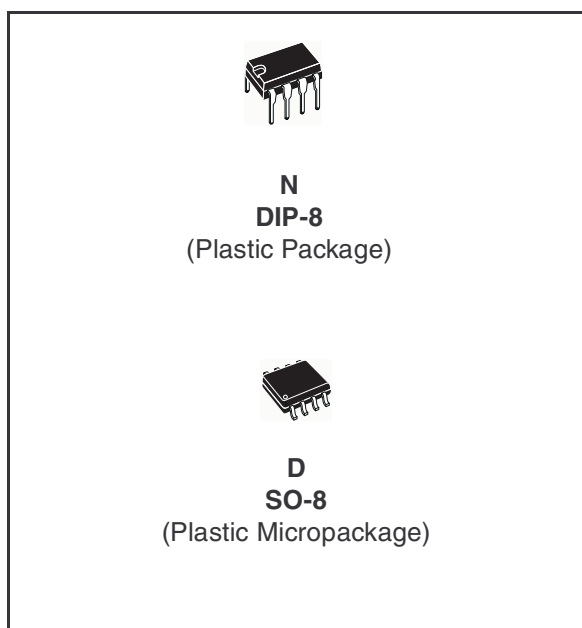
The input voltage range  $V_{icm}$  includes the two supply rails  $V_{CC}^+$  and  $V_{CC}^-$ .

The output reaches:

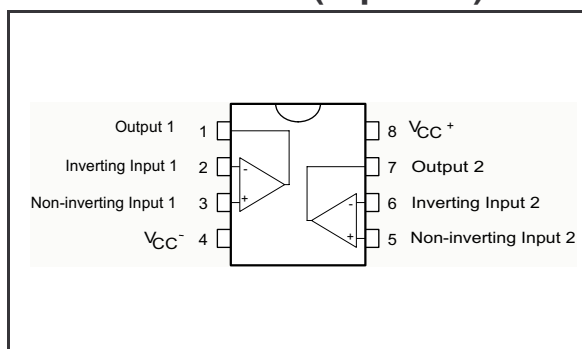
- $V_{CC}^- + 30mV$ ,  $V_{CC}^+ - 40mV$ , with  $R_L = 10k\Omega$
- $V_{CC}^- + 300mV$ ,  $V_{CC}^+ - 400mV$ , with  $R_L = 600\Omega$

This product offers a broad supply voltage operating range from 2.7V to 16V and a supply current of only 200μA/amp ( $V_{CC} = 3V$ ).

Source and sink output current capability is typically 40mA (at  $V_{CC} = 3V$ ), fixed by an internal limitation circuit.



### Pin Connections (top view)



## Order Codes

Part Number	Temperature Range	Package	Packing	Marking
TS912IN	-40, +125°C	DIP8	Tube	TS912IN
TS912ID/IDT		SO-8	Tube or Tape & Reel	912I
TS912AIN		DIP8	Tube	TS912AIN
TS912AID/AIDT		SO-8	Tube or Tape & Reel	912AI
TS912BID/BIDT		SO-8		912BI
TS912IYD/IYDT		SO-8 (automotive grade level)		912IY
TS912AIYD/AIYDT				912AIY

# 1 Absolute Maximum Ratings

**Table 1. Key parameters and their absolute maximum ratings**

Symbol	Parameter	Value	Unit
$V_{CC}$	Supply voltage <sup>(1)</sup>	18	V
$V_{id}$	Differential Input Voltage <sup>(2)</sup>	$\pm 18$	V
$V_i$	Input Voltage <sup>(3)</sup>	-0.3 to 18	V
$I_{in}$	Current on Inputs	$\pm 50$	mA
$I_o$	Current on Outputs	$\pm 130$	mA
$T_{oper}$	Operating Free Air Temperature Range TS912I/AI/BI	-40 to + 125	°C
$T_{stg}$	Storage Temperature	-65 to +150	°C
ESD	HBM: Human Body Model <sup>(4)</sup>	3	kV
	MM: Machine Model <sup>(5)</sup>	200	V
	CDM: Charged Device Model	1500	V

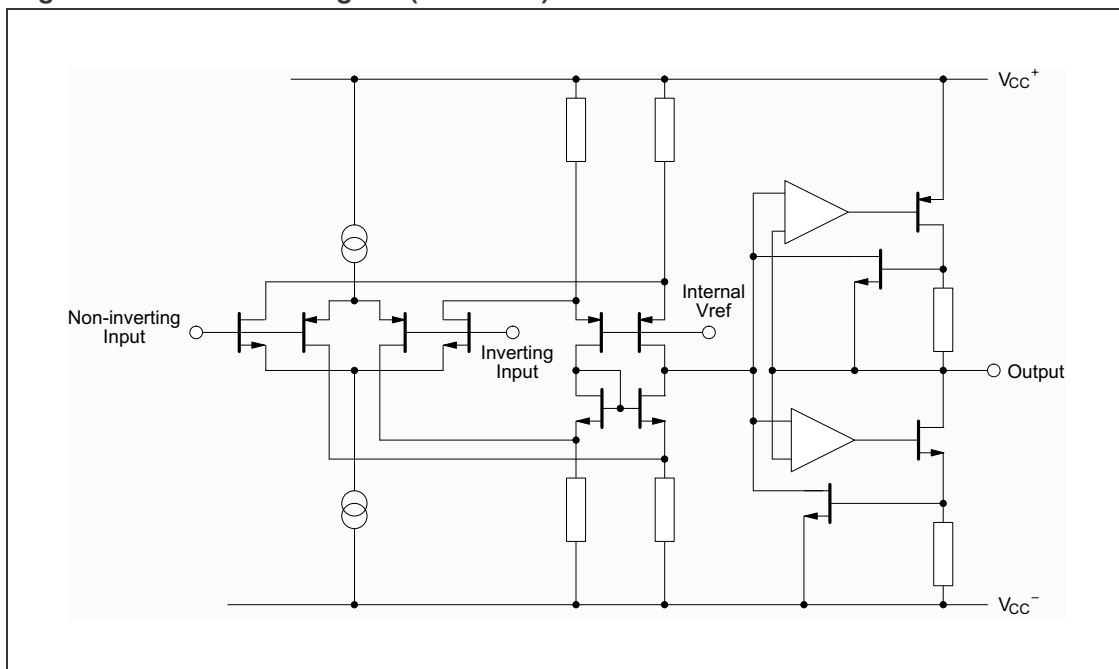
1. All voltages values, except differential voltage are with respect to network ground terminal.
2. Differential voltages are non-inverting input terminal with respect to the inverting input terminal.
3. The magnitude of input and output voltages must never exceed  $V_{CC}^+ + 0.3V$ .
4. Human body model, 100pF discharged through a 1.5k $\Omega$  resistor into pin of device.
5. Machine model ESD, a 200pF cap is charged to the specified voltage, then discharged directly into the IC with no external series resistor (internal resistor < 5 $\Omega$ ), into pin to pin of device.

**Table 2. Operating conditions**

Symbol	Parameter	Value	Unit
$V_{CC}$	Supply voltage	2.7 to 16	V
$V_{icm}$	Common Mode Input Voltage Range	$V_{CC}^- - 0.2$ to $V_{CC}^+ + 0.2$	V

## 2 Typical Application Information

Figure 1. Schematic diagram (1/2 TS912)



### 3 Electrical Characteristics

**Table 3.**  $V_{CC}^+ = 3V$ ,  $V_{CC}^- = 0V$ ,  $R_L$ ,  $C_L$  connected to  $V_{CC}/2$ ,  $T_{amb} = 25^\circ C$  (unless otherwise specified)

Symbol	Parameter	Min.	Typ.	Max.	Unit
$V_{io}$	Input Offset Voltage ( $V_{ic} = V_o = V_{CC}/2$ ) TS912			10	mV
	TS912A			5	
	TS912B			2	
	$T_{min.} \leq T_{amb} \leq T_{max.}$ TS912			12	
	TS912A			7	
	TS912B			3	
$\Delta V_{io}$	Input Offset Voltage Drift		5		$\mu V/^\circ C$
$I_{io}$	Input Offset Current <sup>(1)</sup> $T_{min.} \leq T_{amb} \leq T_{max.}$		1	100 200	pA
$I_{ib}$	Input Bias Current <sup>(1)</sup> $T_{min.} \leq T_{amb} \leq T_{max.}$		1	150 300	pA
$I_{CC}$	Supply Current (per amplifier, $A_{VCL} = 1$ , no load) $T_{min.} \leq T_{amb} \leq T_{max.}$		200	300 400	$\mu A$
CMR	Common Mode Rejection Ratio $V_{ic} = 0$ to $3V$ , $V_o = 1.5V$		70		dB
SVR	Supply Voltage Rejection Ratio ( $V_{CC}^+ = 2.7$ to $3.3V$ , $V_o = V_{CC}/2$ )	50	80		dB
$A_{vd}$	Large Signal Voltage Gain ( $R_L = 10k\Omega$ , $V_o = 1.2V$ to $1.8V$ ) $T_{min.} \leq T_{amb} \leq T_{max.}$	3 2	10		V/mV
$V_{OH}$	High Level Output Voltage ( $V_{id} = 1V$ )				V
	$R_L = 100k\Omega$	2.95			
	$R_L = 10k\Omega$	2.9	2.96		
	$R_L = 600\Omega$	2.3	2.6		
	$R_L = 100\Omega$		2		
	$T_{min.} \leq T_{amb} \leq T_{max.}$ , $R_L = 10k\Omega$	2.8			
	$R_L = 600\Omega$	2.1			
$V_{OL}$	Low Level Output Voltage ( $V_{id} = -1V$ )			50	mV
	$R_L = 100k\Omega$		30	70	
	$R_L = 10k\Omega$		300	400	
	$R_L = 600\Omega$		900		
	$R_L = 100\Omega$				
	$T_{min.} \leq T_{amb} \leq T_{max.}$ , $R_L = 10k\Omega$			100	
	$R_L = 600\Omega$			600	
$I_o$	Output Short Circuit Current ( $V_{id} = \pm 1V$ )				mA
	Source ( $V_o = V_{CC}^-$ )	20	40		
	Sink ( $V_o = V_{CC}^+$ )	20	40		
GBP	Gain Bandwidth Product ( $A_{VCL} = 100$ , $R_L = 10k\Omega$ , $C_L = 100pF$ , $f = 100kHz$ )		0.8		MHz

**Table 3.**  $V_{CC}^+ = 3V, V_{CC}^- = 0V, R_L, C_L$  connected to  $V_{CC/2}, T_{amb} = 25^\circ C$  (unless otherwise specified)

Symbol	Parameter	Min.	Typ.	Max.	Unit
SR <sup>+</sup>	Slew Rate ( $A_{VCL} = 1, R_L = 10k\Omega, C_L = 100pF, V_i = 1.3V$ to $1.7V$ )		0.4		V/ $\mu$ s
SR <sup>-</sup>	Slew Rate ( $A_{VCL} = 1, R_L = 10k\Omega, C_L = 100pF, V_i = 1.3V$ to $1.7V$ )		0.3		V/ $\mu$ s
$\phi_m$	Phase Margin		30		Degrees
en	Equivalent Input Noise Voltage ( $R_s = 100\Omega, f = 1kHz$ )		30		nV/ $\sqrt{Hz}$

1. Maximum values including unavoidable inaccuracies of the industrial test

**Table 4.**  $V_{CC}^+ = 5V, V_{CC}^- = 0V, R_L, C_L$  connected to  $V_{CC/2}, T_{amb} = 25^\circ C$  (unless otherwise specified)

Symbol	Parameter	Min.	Typ.	Max.	Unit
$V_{io}$	Input Offset Voltage ( $V_{ic} = V_o = V_{CC/2}$ )TS912 TS912A TS912B $T_{min.} \leq T_{amb} \leq T_{max.}$ TS912 TS912A TS912B			10 5 2 12 7 3	mV
$\Delta V_{io}$	Input Offset Voltage Drift		5		$\mu$ V/ $^\circ$ C
$I_{io}$	Input Offset Current <sup>(1)</sup> $T_{min.} \leq T_{amb} \leq T_{max.}$		1	100 200	pA
$I_{ib}$	Input Bias Current <sup>(1)</sup> $T_{min.} \leq T_{amb} \leq T_{max.}$		1	150 300	pA
$I_{CC}$	Supply Current (per amplifier, $A_{VCL} = 1$ , no load) $T_{min.} \leq T_{amb} \leq T_{max.}$		230	350 450	$\mu$ A
CMR	Common Mode Rejection Ratio $V_{ic} = 1.5$ to $3.5V, V_o = 2.5V$	60	85		dB
SVR	Supply Voltage Rejection Ratio ( $V_{CC}^+ = 3$ to $5V, V_o = V_{CC/2}$ )	55	80		dB
$A_{vd}$	Large Signal Voltage Gain ( $R_L = 10k\Omega, V_o = 1.5V$ to $3.5V$ ) $T_{min.} \leq T_{amb} \leq T_{max.}$	10 7	40		V/mV
$V_{OH}$	High Level Output Voltage ( $V_{id} = 1V$ ) $R_L = 100k\Omega$ $R_L = 10k\Omega$ $R_L = 600\Omega$ $R_L = 100\Omega$ $T_{min.} \leq T_{amb} \leq T_{max.}, R_L = 10k\Omega$ $R_L = 600\Omega$	4.95 4.9 4.25 4.8 4.1	4.95 4.55 3.7		V

**Table 4.**  $V_{CC}^+ = 5V, V_{CC}^- = 0V, R_L, C_L$  connected to  $V_{CC/2}, T_{amb} = 25^\circ C$  (unless otherwise specified)

Symbol	Parameter	Min.	Typ.	Max.	Unit
$V_{OL}$	Low Level Output Voltage ( $V_{id} = -1V$ )			50	mV
	$R_L = 100k\Omega$		40	100	
	$R_L = 10k\Omega$		350	500	
	$R_L = 600\Omega$		1400		
	$R_L = 100\Omega$			150	
	$T_{min.} \leq T_{amb} \leq T_{max.}, R_L = 10k\Omega$			750	
	$R_L = 600\Omega$				
$I_o$	Output Short Circuit Current ( $V_{id} = \pm 1V$ )				mA
	Source ( $V_o = V_{CC}^-$ )	45	65		
	Sink ( $V_o = V_{CC}^+$ )	45	65		
GBP	Gain Bandwidth Product ( $A_{VCL} = 100, R_L = 10k\Omega, C_L = 100pF, f = 100kHz$ )		1		MHz
$SR^+$	Slew Rate ( $A_{VCL} = 1, R_L = 10k\Omega, C_L = 100pF, V_i = 1V$ to 4V)		0.8		
$SR^-$	Slew Rate ( $A_{VCL} = 1, R_L = 10k\Omega, C_L = 100pF, V_i = 1V$ to 4V)		0.6		V/ $\mu s$
en	Equivalent Input Noise Voltage ( $R_s = 100\Omega, f = 1kHz$ )		30		nV/ $\sqrt{Hz}$
$V_{O1}/V_{O2}$	Channel Separation ( $f = 1kHz$ )		120		dB
$\phi_m$	Phase Margin		30		Degrees

1. Maximum values including unavoidable inaccuracies of the industrial test

**Table 5.**  $V_{CC}^+ = 10V, V_{CC}^- = 0V, R_L, C_L$  connected to  $V_{CC/2}, T_{amb} = 25^\circ C$  (unless otherwise specified)

Symbol	Parameter	Min.	Typ.	Max.	Unit
$V_{io}$	Input Offset Voltage ( $V_{ic} = V_o = V_{CC/2}$ )TS912			10	mV
	TS912A			5	
	TS912B			2	
	$T_{min.} \leq T_{amb} \leq T_{max.}$ TS912			12	
	TS912A			7	
	TS912B			3	
$\Delta V_{io}$	Input Offset Voltage Drift		5		$\mu V/^\circ C$
$I_{io}$	Input Offset Current <sup>(1)</sup>		1	100	pA
	$T_{min.} \leq T_{amb} \leq T_{max.}$			200	
$I_{ib}$	Input Bias Current <sup>(1)</sup>		1	150	pA
	$T_{min.} \leq T_{amb} \leq T_{max.}$			300	
$I_{CC}$	Supply Current (per amplifier, $A_{VCL} = 1$ , no load)		400	600	$\mu A$
	$T_{min.} \leq T_{amb} \leq T_{max.}$			700	
CMR	Common Mode Rejection Ratio				dB
	$V_{ic} = 3$ to 7V, $V_o = 5V$	60	90		
	$V_{ic} = 0$ to 10V, $V_o = 5V$	50	75		

**Table 5.**  $V_{CC}^+ = 10V, V_{CC}^- = 0V, R_L, C_L$  connected to  $V_{CC}/2, T_{amb} = 25^\circ C$  (unless otherwise specified)

Symbol	Parameter	Min.	Typ.	Max.	Unit
SVR	Supply Voltage Rejection Ratio ( $V_{CC}^+ = 5$ to $10V, V_o = V_{CC}/2$ )	60	90		dB
$A_{vd}$	Large Signal Voltage Gain ( $R_L = 10k\Omega, V_o = 2.5V$ to $7.5V$ ) $T_{min.} \leq T_{amb} \leq T_{max.}$	15 10	50		V/mV
$V_{OH}$	High Level Output Voltage ( $V_{id} = 1V$ ) $R_L = 100k\Omega$ $R_L = 10k\Omega$ $R_L = 600\Omega$ $R_L = 100\Omega$ $T_{min.} \leq T_{amb} \leq T_{max.}, R_L = 10k\Omega$ $R_L = 600\Omega$	9.95 9.85 9 9.8 8.8	9.95 9.35 7.8		V
$V_{OL}$	Low Level Output Voltage ( $V_{id} = -1V$ ) $R_L = 100k\Omega$ $R_L = 10k\Omega$ $R_L = 600\Omega$ $R_L = 100\Omega$ $T_{min.} \leq T_{amb} \leq T_{max.}, R_L = 10k\Omega$ $R_L = 600\Omega$		50 650 2300	50 150 800 150 900	mV
$I_o$	Output Short Circuit Current ( $V_{id} = \pm 1V$ ) Source ( $V_o = V_{CC}^-$ ) Sink ( $V_o = V_{CC}^+$ )	45 50	65 75		mA
GBP	Gain Bandwidth Product ( $A_{VCL} = 100, R_L = 10k\Omega, C_L = 100pF, f = 100kHz$ )		1.4		MHz
$SR^+$	Slew Rate ( $A_{VCL} = 1, R_L = 10k\Omega, C_L = 100pF, V_i = 2.5V$ to $7.5V$ )		1.3		V/ $\mu s$
$SR^-$	Slew Rate ( $A_{VCL} = 1, R_L = 10k\Omega, C_L = 100pF, V_i = 2.5V$ to $7.5V$ )		0.8		
$\phi_m$	Phase Margin		40		Degrees
$e_n$	Equivalent Input Noise Voltage ( $R_s = 100\Omega, f = 1kHz$ )		30		nV/ $\sqrt{Hz}$
THD	Total Harmonic Distortion ( $A_{VCL} = 1, R_L = 10k\Omega, C_L = 100pF, V_o = 4.75V$ to $5.25V, f = 1kHz$ )		0.02		%
$C_{in}$	Input Capacitance		1.5		pF

1. Maximum values including unavoidable inaccuracies of the industrial test



Figure 2. Supply current (each amplifier) vs. supply voltage

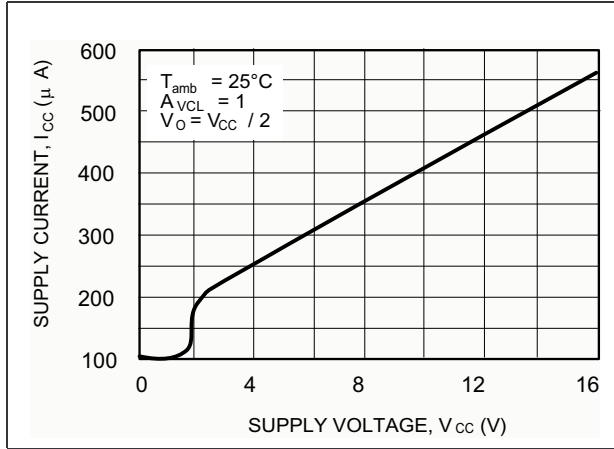


Figure 3. High level output voltage vs. high level output current

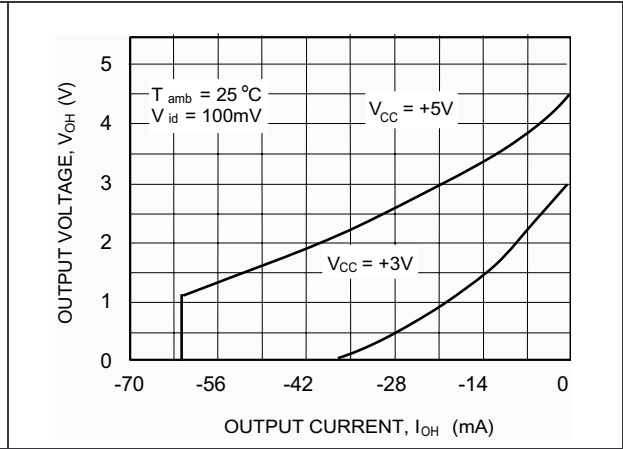


Figure 4. Low level output voltage vs. low level output current

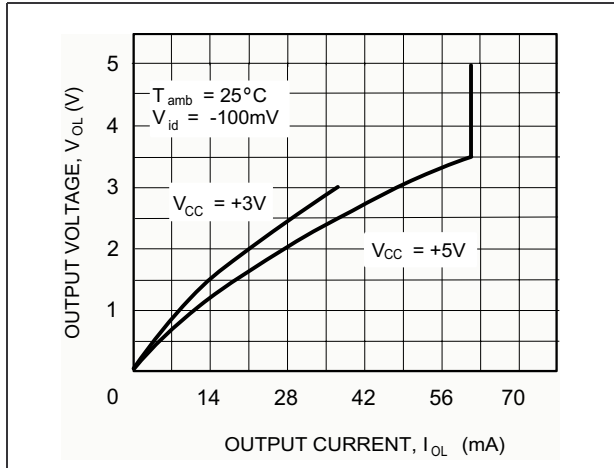


Figure 5. Input bias current vs. temperature

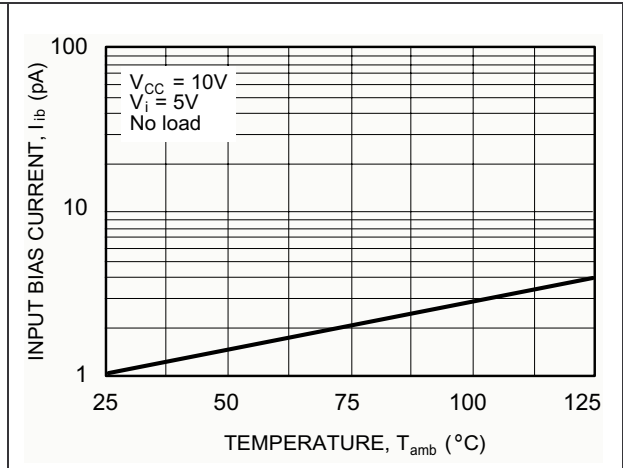


Figure 6. High level output voltage vs. high level output current

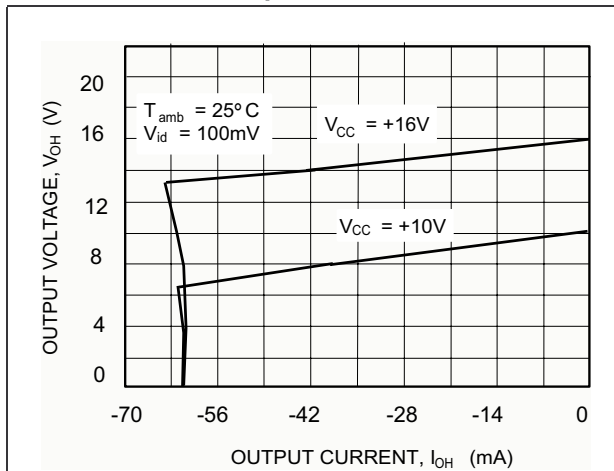


Figure 7. Low level output voltage vs. low level output current

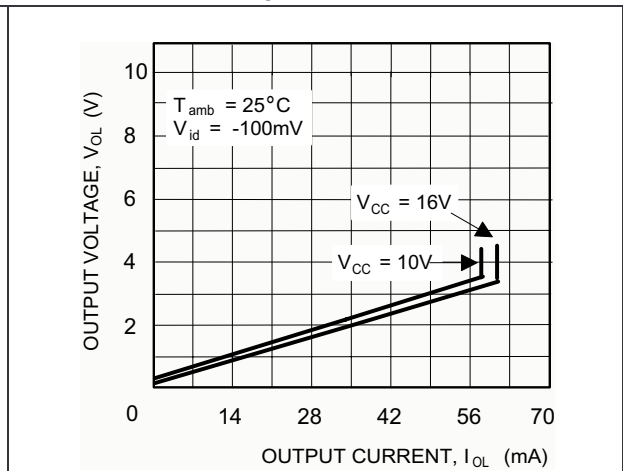


Figure 8. Gain and phase vs. frequency

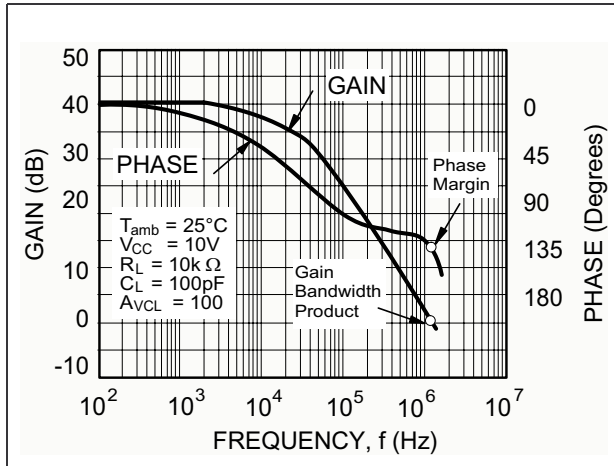


Figure 9. Gain bandwidth product vs. supply voltage

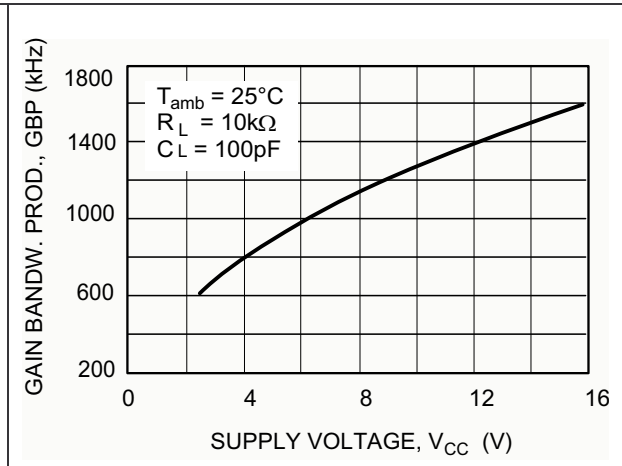


Figure 10. Phase margin vs. supply voltage

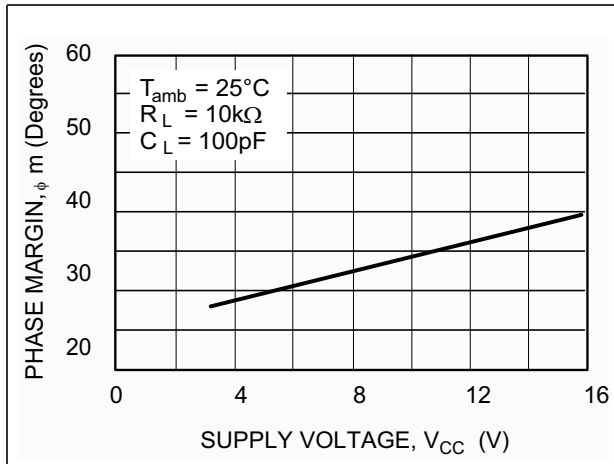


Figure 11. Gain and phase vs. frequency

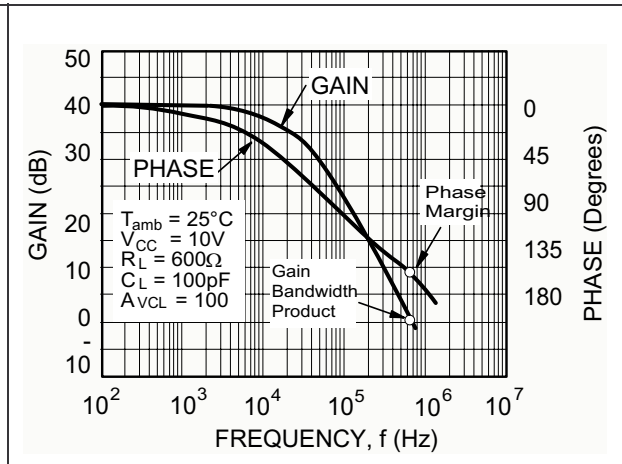


Figure 12. Gain bandwidth product vs. supply voltage

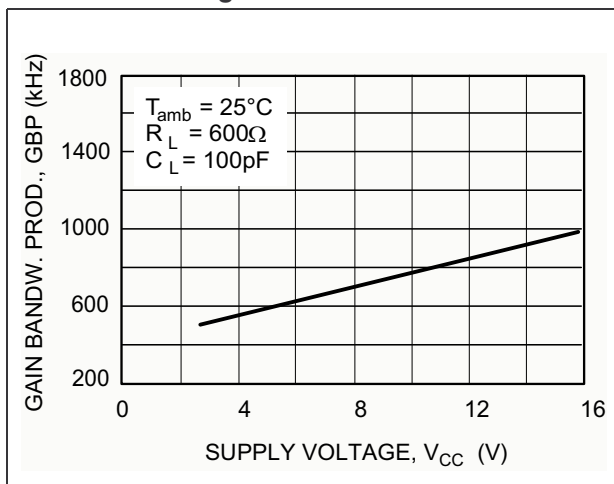


Figure 13. Phase margin vs. supply voltage

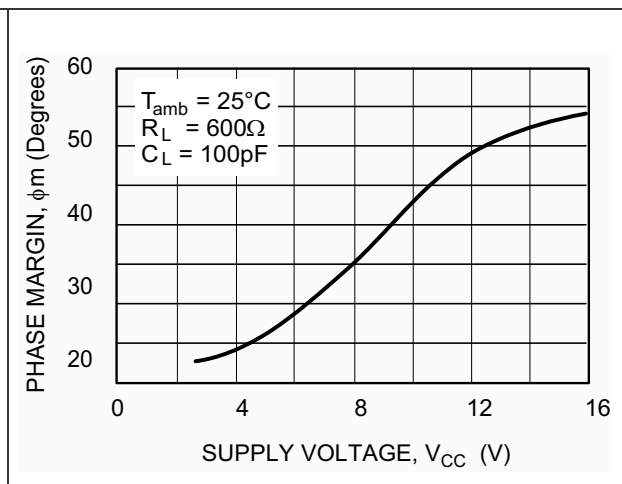
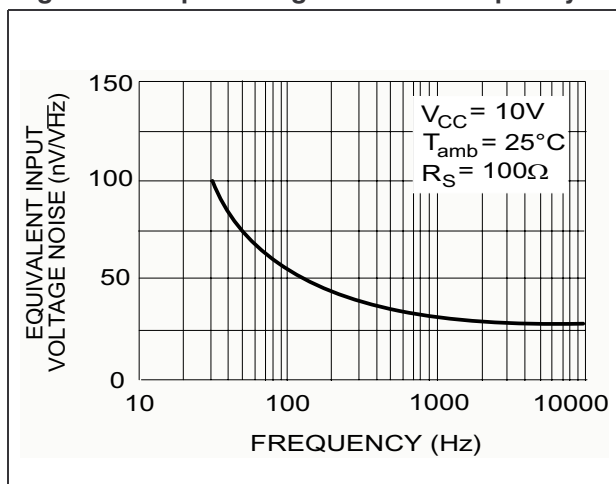


Figure 14. Input voltage noise vs. frequency



## 4 Macromodels

### 4.1 Important note concerning this macromodel

Please consider following remarks before using this macromodel.

- All models are a trade-off between accuracy and complexity (i.e. simulation time).
- Macromodels are not a substitute to breadboarding; rather, they confirm the validity of a design approach and help to select surrounding component values.
- A macromodel emulates the NOMINAL performance of a TYPICAL device within SPECIFIED OPERATING CONDITIONS (i.e. temperature, supply voltage, etc.). Thus the macromodel is often not as exhaustive as the datasheet, its goal is to illustrate the main parameters of the product.
- Data issued from macromodels used outside of its specified conditions ( $V_{CC}$ , Temperature, etc.) or even worse: outside of the device operating conditions ( $V_{CC}$ ,  $V_{icm}$ , etc.) are not reliable in any way.

In *Section 4.2* and *Section 4.4*, the electrical characteristics resulting from the use of these macromodels are presented.

### 4.2 Electrical characteristics from macromodelization

**Table 6.** Electrical characteristics resulting from macromodel simulation at  $V_{CC}^+ = 3V$ ,  $V_{CC}^- = 0V$ ,  $R_L$ ,  $C_L$  connected to  $V_{CC}/2$ ,  $T_{amb} = 25^\circ C$  (unless otherwise specified)

Symbol	Conditions	Value	Unit
$V_{io}$		0	mV
$A_{vd}$	$R_L = 10k\Omega$	10	V/mV
$I_{CC}$	No load, per operator	200	$\mu A$
$V_{icm}$		-0.2 to 3.2	V
$V_{OH}$	$R_L = 10k\Omega$	2.96	V
$V_{OL}$	$R_L = 10k\Omega$	30	mV
$I_{sink}$	$V_O = 3V$	40	mA
$I_{source}$	$V_O = 0V$	40	mA
GBP	$R_L = 10k\Omega$ , $C_L = 100pF$	0.8	MHz
SR	$R_L = 10k\Omega$ , $C_L = 100pF$	0.3	V/ $\mu s$

### 4.3 Macromodel code

**Applies to: TS912 ( $V_{CC} = 3V$ )**

\*\* Standard Linear Ics Macromodels, 1993.

\*\* CONNECTIONS :

\* 1 INVERTING INPUT

```

* 2 NON-INVERTING INPUT
* 3 OUTPUT
* 4 POSITIVE POWER SUPPLY
* 5 NEGATIVE POWER SUPPLY
.SUBCKT TS912_3 1 3 2 4 5 (analog)
*****
.MODEL MDTH D IS=1E-8 KF=6.564344E-14 CJO=10F
* INPUT STAGE
CIP 2 5 1.000000E-12
CIN 1 5 1.000000E-12
EIP 10 5 2 5 1
EIN 16 5 1 5 1
RIP 10 11 6.500000E+00
RIN 15 16 6.500000E+00
RIS 11 15 1.271505E+01
DIP 11 12 MDTH 400E-12
DIN 15 14 MDTH 400E-12
VOFP 12 13 DC 0.000000E+00
VOFN 13 14 DC 0
IPOL 13 5 4.000000E-05
CPS 11 15 2.125860E-08
DINN 17 13 MDTH 400E-12
VIN 17 5 0.000000E+00
DINR 15 18 MDTH 400E-12
VIP 4 18 0.000000E+00
FCP 4 5 VOFP 5.000000E+00
FCN 5 4 VOFN 5.000000E+00
* AMPLIFYING STAGE
FIP 5 19 VOFP 2.750000E+02
FIN 5 19 VOFN 2.750000E+02
RG1 19 5 1.916825E+05
RG2 19 4 1.916825E+05
CC 19 29 2.200000E-08
HZTP 30 29 VOFP 1.3E+03
HZTN 5 30 VOFN 1.3E+03
DOPM 19 22 MDTH 400E-12
DONM 21 19 MDTH 400E-12
HOPM 22 28 VOUT 3800
VIPM 28 4 150
HONM 21 27 VOUT 3800
VINM 5 27 150
EOUT 26 23 19 5 1
VOUT 23 5 0
ROUT 26 3 75
COUT 3 5 1.000000E-12
DOP 19 68 MDTH 400E-12
VOP 4 25 1.724
HSCP 68 25 VSCP1 0.8E8
DON 69 19 MDTH 400E-12
VON 24 5 1.7419107
HSCN 24 69 VSCN1 0.8E+08
VSCTHP 60 61 0.0875
** VSCTHP = le seuil au dessus de vio * 500
** c.a.d 275U-000U dus a l'offset
DSCP1 61 63 MDTH 400E-12
VSCP1 63 64 0
ISCP 64 0 1.000000E-8
DSCP2 0 64 MDTH 400E-12
DSCN2 0 74 MDTH 400E-12
ISCN 74 0 1.000000E-8
VSCN1 73 74 0
DSCN1 71 73 MDTH 400E-12
VSCTHN 71 70 -0.55

```

```

** VSCTHN = le seuil au dessous de vio * 2000
** c.a.d -375U-000U dus a l'offset
ESCP 60 0 2 1 500
ESCN 70 0 2 1 -2000
.ENDS

```

#### 4.4 Electrical characteristics from macromodelization

Table 7. Electrical characteristics resulting from macromodel simulation at  $V_{CC}^+ = 5V$ ,  $V_{CC}^- = 0V$ ,  $R_L$ ,  $C_L$  connected to  $V_{CC}/2$ ,  $T_{amb} = 25^\circ C$  (unless otherwise specified)

Symbol	Conditions	Value	Unit
$V_{io}$		0	mV
$A_{vd}$	$R_L = 10k\Omega$	50	V/mV
$I_{CC}$	No load, per operator	230	$\mu A$
$V_{icm}$		-0.2 to 5.2	V
$V_{OH}$	$R_L = 10k\Omega$	4.95	V
$V_{OL}$	$R_L = 10k\Omega$	40	mV
$I_{sink}$	$V_O = 5V$	65	mA
$I_{source}$	$V_O = 0V$	65	mA
GBP	$R_L = 10k\Omega$ , $C_L = 100pF$	1	MHz
SR	$R_L = 10k\Omega$ , $C_L = 100pF$	0.8	V/ $\mu s$

#### 4.5 Macromodel code

##### Applies to: TS912 ( $V_{cc} = 5V$ )

```

** Standard Linear Ics Macromodels, 1993.
** CONNECTIONS :
* 1 INVERTING INPUT
* 2 NON-INVERTING INPUT
* 3 OUTPUT
* 4 POSITIVE POWER SUPPLY
* 5 NEGATIVE POWER SUPPLY
* 6 STANDBY
.SUBCKT TS912_5 1 3 2 4 5 (analog)
*****
.MODEL MDTH D IS=1E-8 KF=6.564344E-14 CJO=10F
* INPUT STAGE
CIP 2 5 1.000000E-12
CIN 1 5 1.000000E-12
EIP 10 5 2 5 1
EIN 16 5 1 5 1
RIP 10 11 6.500000E+00
RIN 15 16 6.500000E+00
RIS 11 15 7.322092E+00
DIP 11 12 MDTH 400E-12
DIN 15 14 MDTH 400E-12
VOFP 12 13 DC 0.000000E+00
VOFN 13 14 DC 0

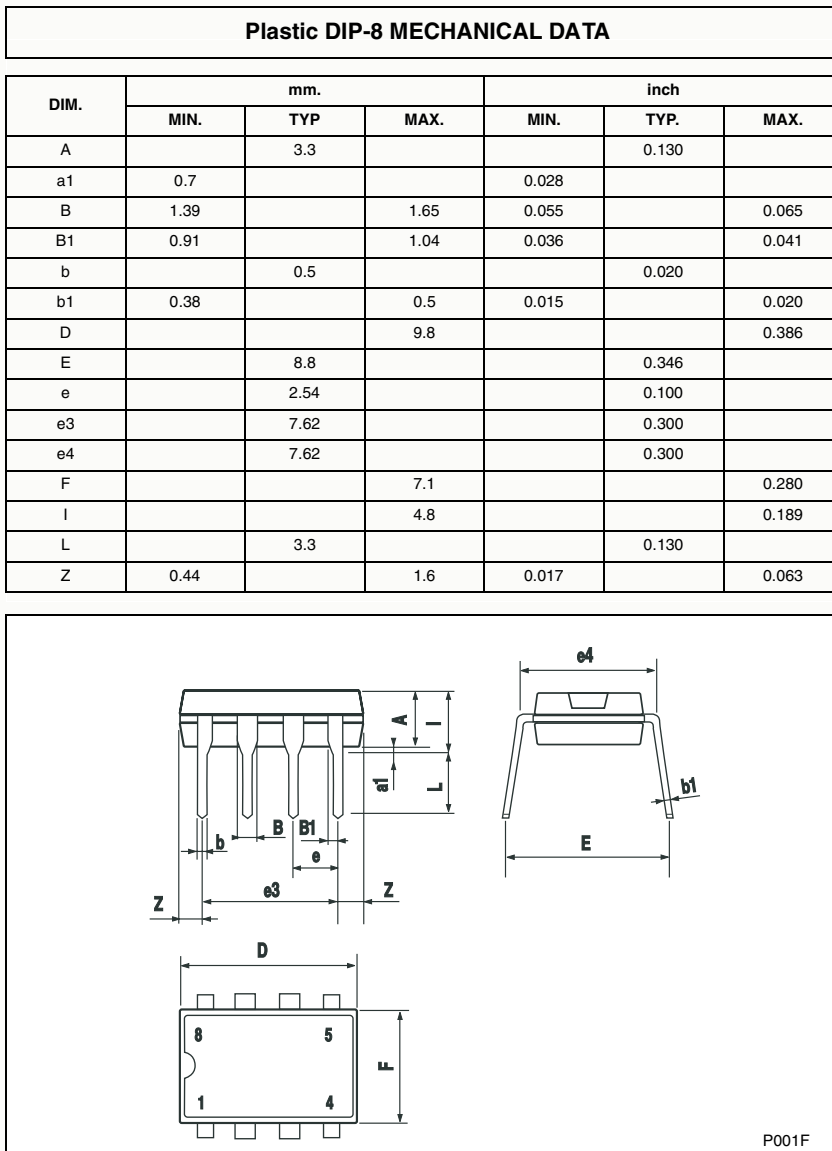
```

```
IPOL 13 5 4.000000E-05
CPS 11 15 2.498970E-08
DINN 17 13 MDTH 400E-12
VIN 17 5 0.000000e+00
DINR 15 18 MDTH 400E-12
VIP 4 18 0.000000E+00
FCP 4 5 VOFP 5.750000E+00
FCN 5 4 VOFN 5.750000E+00
ISTB0 5 4 500N
* AMPLIFYING STAGE
FIP 5 19 VOFP 4.400000E+02
FIN 5 19 VOFN 4.400000E+02
RG1 19 5 4.904961E+05
RG2 19 4 4.904961E+05
CC 19 29 2.200000E-08
HZTP 30 29 VOFP 1.8E+03
HZTN 5 30 VOFN 1.8E+03
DOPM 19 22 MDTH 400E-12
DONM 21 19 MDTH 400E-12
HOPM 22 28 VOUT 3800
VIPM 28 4 230
HONM 21 27 VOUT 3800
VINM 5 27 230
EOUT 26 23 19 5 1
VOUT 23 5 0
ROUT 26 3 82
COUT 3 5 1.000000E-12
DOP 19 68 MDTH 400E-12
VOP 4 25 1.724
HSCP 68 25 VSCP1 0.8E+08
DON 69 19 MDTH 400E-12
VON 24 5 1.7419107
HSCN 24 69 VSCN1 0.8E+08
VSCTHP 60 61 0.0875
** VSCTHP = le seuil au dessus de vio * 500
** c.a.d 275U-000U dus a l'offset
DSCP1 61 63 MDTH 400E-12
VSCP1 63 64 0
ISCP 64 0 1.000000E-8
DSCP2 0 64 MDTH 400E-12
DSCN2 0 74 MDTH 400E-12
ISCN 74 0 1.000000E-8
VSCN1 73 74 0
DSCN1 71 73 MDTH 400E-12
VSCTHN 71 70 -0.55
** VSCTHN = le seuil au dessous de vio * 2000
** c.a.d -375U-000U dus a l'offset
ESCP 60 0 2 1 500
ESCN 70 0 2 1 -2000
.ENDS
```

## 5 Package Mechanical Data

In order to meet environmental requirements, ST offers these devices in ECOPACK<sup>®</sup> packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: [www.st.com](http://www.st.com).

### 5.1 DIP-8 Package

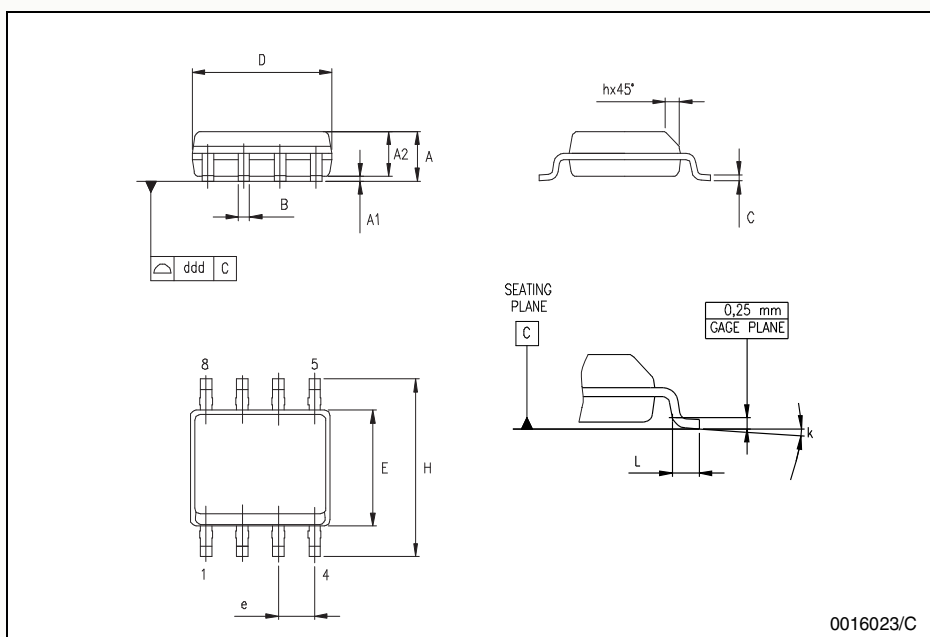




## 5.2 SO-8 Package

**SO-8 MECHANICAL DATA**

DIM.	mm.			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A	1.35		1.75	0.053		0.069
A1	0.10		0.25	0.04		0.010
A2	1.10		1.65	0.043		0.065
B	0.33		0.51	0.013		0.020
C	0.19		0.25	0.007		0.010
D	4.80		5.00	0.189		0.197
E	3.80		4.00	0.150		0.157
e		1.27			0.050	
H	5.80		6.20	0.228		0.244
h	0.25		0.50	0.010		0.020
L	0.40		1.27	0.016		0.050
k	8° (max.)					
ddd			0.1			0.04



## 6 Revision History

Date	Revision	Changes
Dec. 2001	1	First Release
July 2005	2	1 - PPAP references inserted in the datasheet see <i>Table : Order Codes on page 2</i> 2 - ESD protection inserted in <i>Table 1: Key parameters and their absolute maximum ratings on page 3</i>
Oct. 2005	3	The following changes were made in this revision: – Some errors in the Order Codes table was corrected <i>on page 2</i> . – Reorganization of <i>Chapter 4: Macromodels on page 12</i> .

Information furnished is believed to be accurate and reliable. However, STMicroelectronics assumes no responsibility for the consequences of use of such information nor for any infringement of patents or other rights of third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of STMicroelectronics. Specifications mentioned in this publication are subject to change without notice. This publication supersedes and replaces all information previously supplied. STMicroelectronics products are not authorized for use as critical components in life support devices or systems without express written approval of STMicroelectronics.

The ST logo is a registered trademark of STMicroelectronics.  
All other names are the property of their respective owners

© 2005 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan - Malaysia - Malta - Morocco - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

[www.st.com](http://www.st.com)